TXG300HF120DK

Product Datasheet
Half Bridge Module
IGBT Module

34mm Module with Trench/Feldstopp IGBT and Fast recovery diode.

Feature

- 300A/1200V,VCE(sat)(typ.) =2.10V@300A
- Trench/Feldstopp IGBT
- Excellent short circuit ruggednes

Applications

- High Power Converters
- Motor Drives
- Uninterrupted Power Supply(UPS)

Appearance

Maximum Ratings of IGBT (T_{vj}=25 ℃ unless otherwise noted)

Items	Symbol	Conditions	Maximum Rating	Units
Collector-emitter voltage	V_{CES}		1200	V
Gate-emitter voltage	V_{GES}		±30	V
Collector current	I_C	T_{vj}=25℃	600	A
		T_{vj}=100℃	300	A
Pulsed collector current	I_{CM}	t_P=1ms	600	A
Short circuit current	I_{sc}	V_{GE}≤15V,V_{CC}=600V,t_P=10us V_{CEmax}=V_{CES}-L_{sCE} ·di/dt	800	A
Maximum power dissipation	P_D	T_c=25℃,T_{vj}=150℃	1100	W

Electrical Characteristics of IGBT (T_{vj}=25 ℃ unless otherwise noted)

Items	Symbol	Conditions	Min.	typ.	Max.	Units
Collector-emitter breakdown voltage	V_{CES}	V_{GE}=0V,I_C=250μA	1200			V
Collector -emitter leakage current	I_{CES}	V_{CE}=1200V,V_{GE}=0V			5.0	mA
Gate leakage current, forward	I_{GES}	V_{GE}=30V,V_{CE}=0V			400	nA
		V_{GE}=-30V,V_{CE}=0V			-400	nA
Gate threshold voltage	$V_{GE(th)}$	V_{GE}=V_{CE},I_C=250μA	5.00	5.80	6.60	V
Collector-emitter saturation voltage	$V_{CE(sat)}$	V_{GE}=15V,I_C=300A,T_{vj}=25℃		1.80	2.20	V
		V_{GE}=15V,I_C=300A,T_{vj}=125℃		2.10		V
Integrated gate resistor	R_{Gint}	f=1M;V_{pp}=1V		2.50		Ω
Input capacitance	C_{ies}	V_{CE}=25V V_{GE}=0V f=1MHz		19.0		nF
Output capacitance	C_{oes}			tdb.		nF
Reverse transfer capacitance	C_{res}			0.81		nF
Total gate charge	Q_g	V_{CC}=600V， V_{GE}=15V,I_C=300A		2.40		uC
Turn-on delay time	$t_{d(on)}$	V_{CC}=600V V_{GE}=±15V I_C=300A R_G=2.0Ω Inductive Load T_{vj}=25℃		160		ns
Rise time	t_r			40		ns
Turn-off delay time	$t_{d(off)}$			450		ns
Fall time	t_f			100		ns
Turn-on energy loss per pulse	E_{on}			16.5		mJ
Turn-off energy loss per pulse	E_{off}			19.5		mJ
Turn-on delay time	$t_{d(on)}$	V_{CC}=600V V_{GE}=±15V I_C=300A R_G=2.0Ω Inductive Load T_{vj}=125℃		170		ns
Rise time	t_r			45		ns
Turn-off delay time	$t_{d(off)}$			520		ns
Fall time	t_f			160		ns
Turn-on energy loss per pulse	E_{on}			25.0		mJ
Turn-off energy loss per pulse	E_{off}			29.5		mJ
Temperature under switching conditions	$T_{vj\ op}$		-55		150	℃

Maximum Ratings of Diode

Items	Symbol	Conditions	Maximum Rating	Units
Repetitive peak reverse voltage	V_{RRM}	T_{vj}=25℃	1200	V
Diode continuous forward current	I_F	T_{vj}=25℃	600	A
		T_{vj}=100℃	300	A
Diode maximum forward current	I_{FM}	t_P=1ms,T_{vj}=25℃	600	A

Electrical s Characteristics of Diode (T_{vj}=25℃ unless otherwise noted)

Items	Symbol	Conditions	Min.	typ.	Max.	Units
Diode forward voltage	V_F	I_F=300A,T_{vj}=25℃		1.70	2.20	V
		I_F=300A,T_{vj}=125℃		1.70		V
Diode reverse recovery time	t_{rr}	V_{CE}=600V I_F=300A d_{IF}/d_t=6000A/μs T_{vj}=25℃		tbd.		ns
Diode peak reverse recovery current	I_{rr}			350		A
Diode reverse recovery charge	Q_{rr}			31.0		uC
Reverse recovery energy	E_{rec}			13.0		mJ
Diode reverse recovery time	t_{rr}	V_{CE}=600V I_F=300A d_{IF}/d_t=6000A/μs T_{vj}=125℃		tbd.		ns
Diode peak reverse recovery current	I_{rr}			380		A
Diode reverse recovery charge	Q_{rr}			48.0		nC
Reverse recovery energy	E_{rec}			23.5		mJ

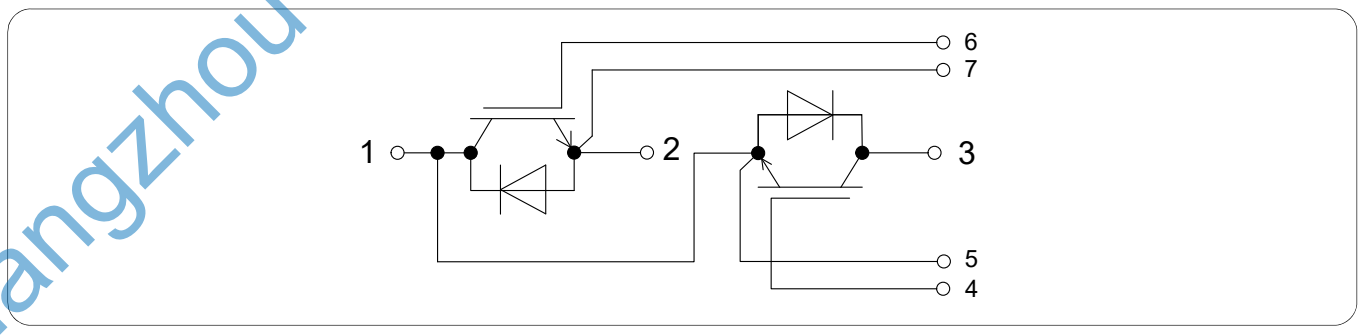
Thermal Characteristics

Items	Symbol	Min.	typ.	Max.	Units
Thermal resistance, junction to case for IGBT	$R_{th\ j\text{-}c}$			0.15	℃/W
Thermal resistance, case to sink	$R_{thC\text{-}S}$		0.05		℃/W

Module Characteristics

Items	Symbol	Conditions	Min.	typ.	Max.	Units
Material of module baseplate				Cu		
Internal isolation		terminal to terminal		Al_2O_3		
Isolation test voltage	V_{isol}	RMS, f = 50 Hz, t = 1 min.	2.5			kV
Stray inductance module	L_{sCE}			30		nH
Mounting torque for modul mounting	M	Screw M6	3.0		5.0	Nm
Terminal connection torque	M	Screw M5	4.0		6.0	Nm
Storage temperature range	T_{STG}		-55		150	℃
Weight of Module	W_t			160		g

Internal Circuit:



Representative Characteristics

Fig 1. Output characteristic IGBT
$I_C=f(V_{CE}),V_{GE}=15V$

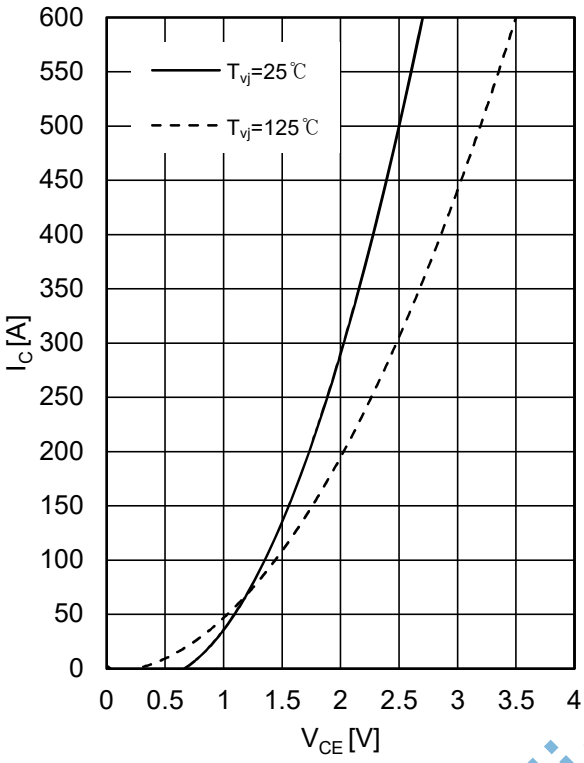


Fig 2. Output characteristic IGBT
$I_C=f(V_{CE})$
T_{vj}=125℃

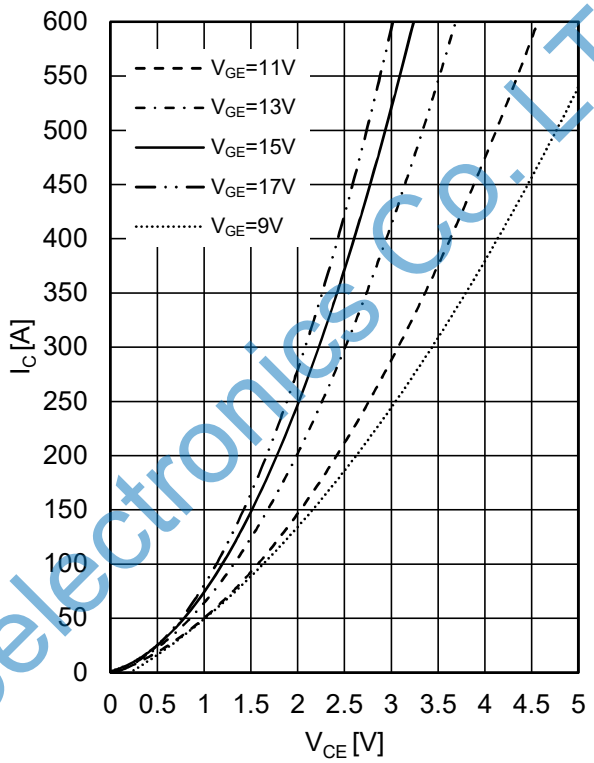


Fig 3. Transfer characteristic IGBT
$I_C=f(V_{GE})$
V_{CE}=20V

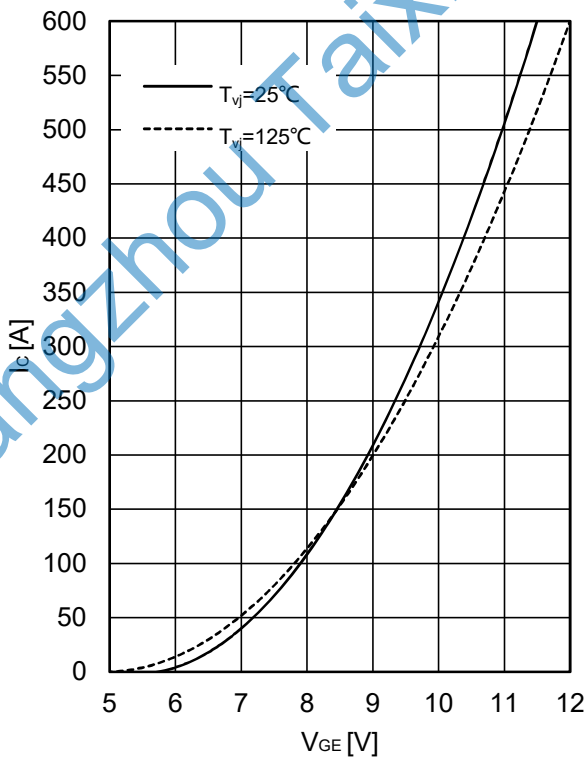


Fig 4. Switching losses IGBT
$E_{on}=f(I_C),E_{off}=f(I_C)$,
V_{GE}=±15V,R_G=2.0Ω,V_{CE}=600V

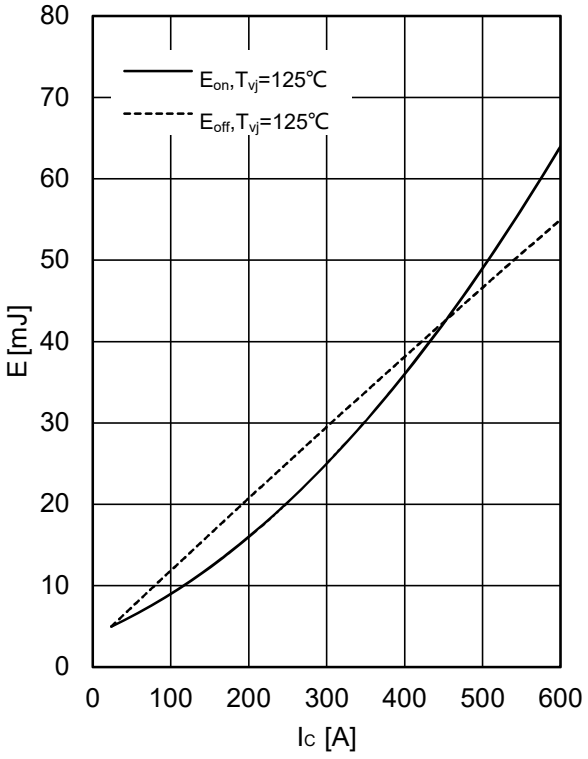


Fig 5. Switching losses IGBT
$E_{on}=f(R_G)$,$E_{off}=f(R_G)$,
$V_{GE}=\pm15V$,$I_C=300A$,$V_{CE}=600V$

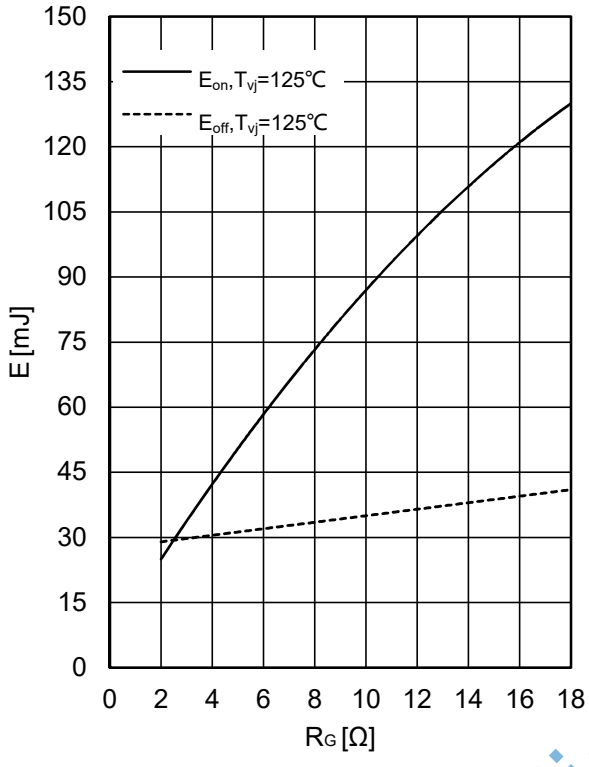


Fig 6. Transient thermal impedance IGBT
$Z_{thjc}=f(t)$

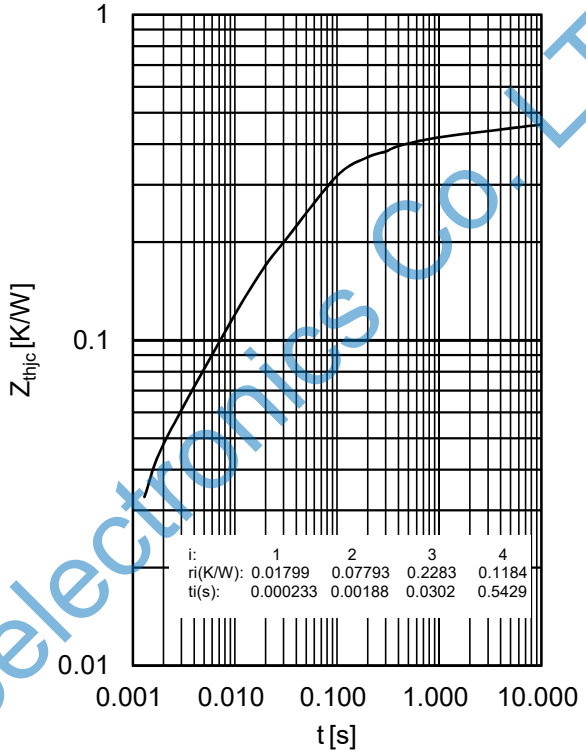


Fig 7. Reverse bias safe operating area IGBT
$I_C=f(V_{CE})$
$V_{GE}=\pm15V$,$R_{Goff}=2.5\Omega$,$T_{vj}=125℃$

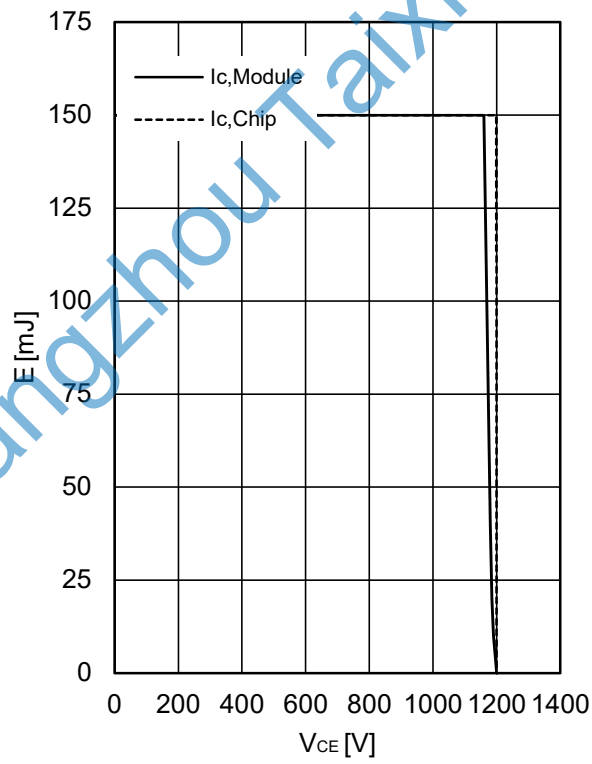


Fig 8. Forward characteristic of Diode
$I_F=f(V_F)$

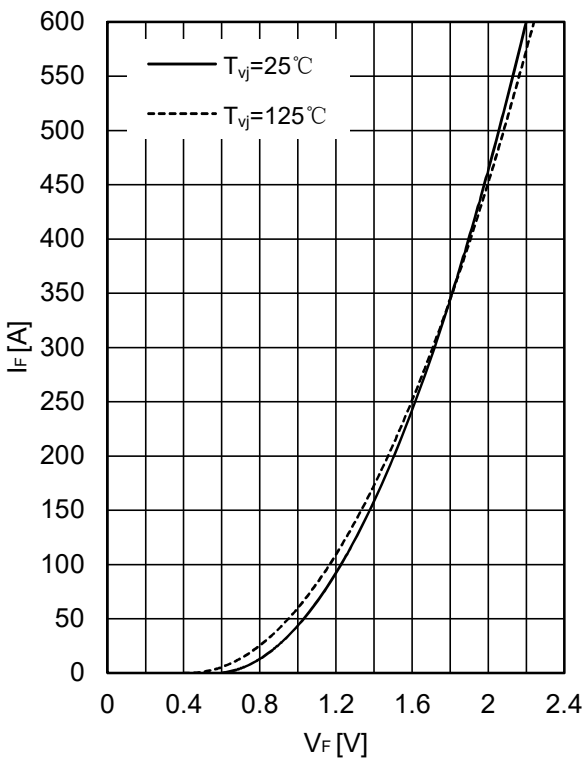


Fig 9. Switching losses Diode
$E_{rec}=f(I_F)$
$R_G=2.0\Omega, V_{CE}=600V$

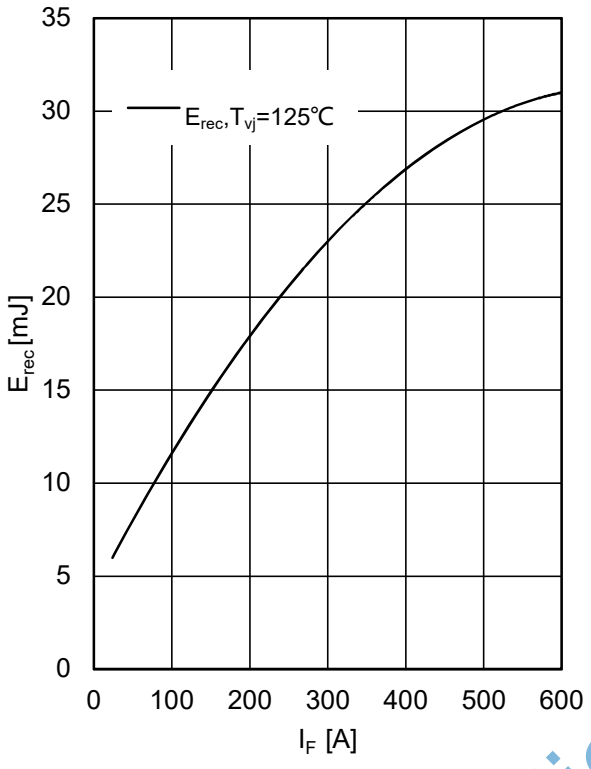
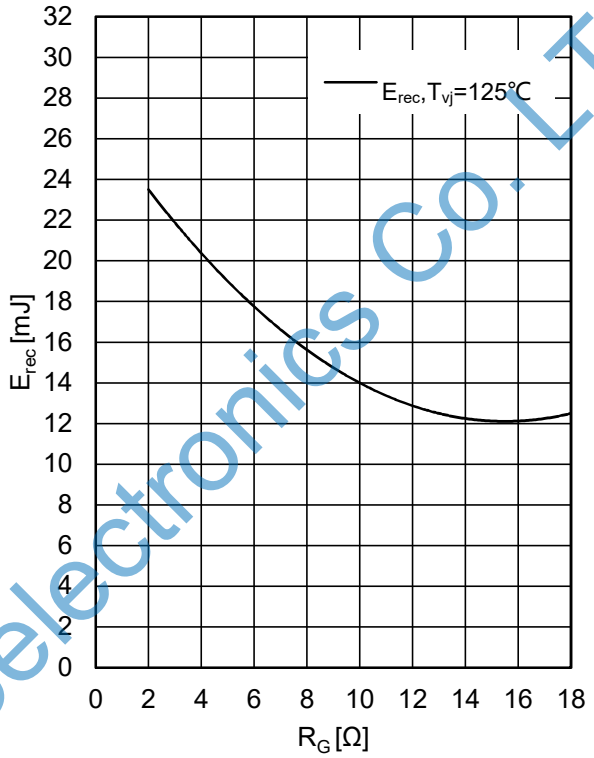
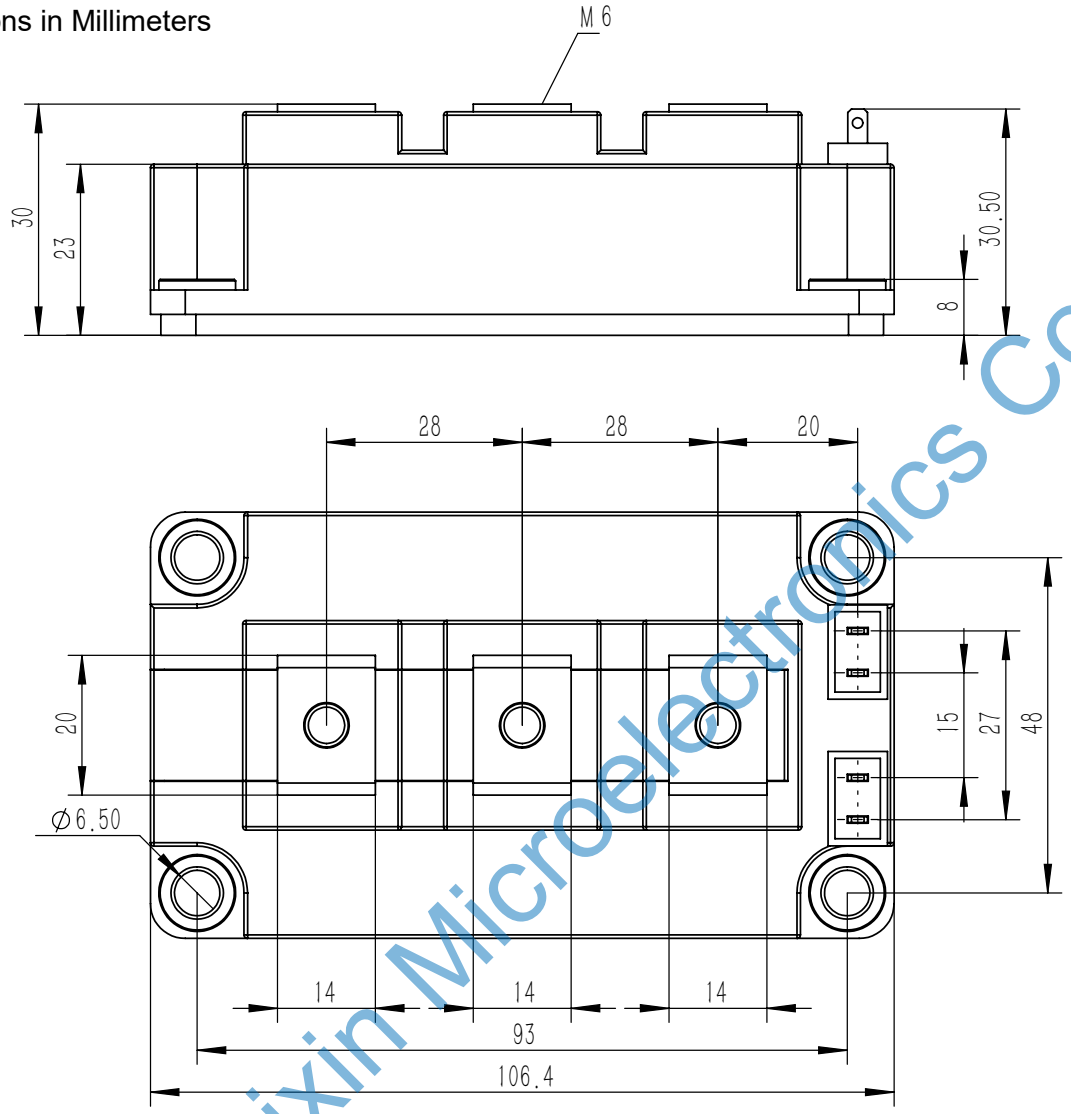


Fig 10. Switching losses Diode
$E_{rec}=f(R_G)$
$I_F=300A, V_{CE}=600V$



Package Dimensions

Dimensions in Millimeters



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